

# **Features**

- 2835 0.7mm SMD LED
- High Brightness
- White package
- High reliability
- Water Clear Lens

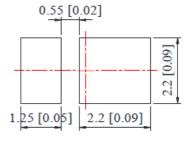
# Applications

- Consumer Electronics
- Wearables
- Automobile After Market
- Industrial Equipment

# Description

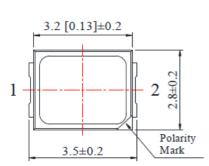
The IN-P23CTJB is a 2835 package with versatile design capabilities. It is a PLCC type LED which can be used in various applications.

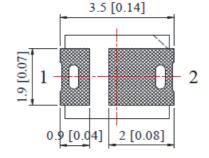
# **Recommended Solder Pattern**



#### Figure 1. IN-P23CTJB Solder Pattern

# Package Dimensions in mm









#### Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is  $\pm$  0.25 mm (.010") unless otherwise noted.

#### Figure 2. IN-P23CTJB Package Dimensions



#### Absolute Maximum Rating at 25°C (Note 1)

Product	Emission Color	P₀ (mW)	l⊧ (mA)	I <sub>FP</sub> * (mA)	V <sub>R</sub> (V)	Top (°C)	Т <sub>ST</sub> (°С)
IN-P23CTJB	Blue	0.2	60	100	5	-40°C~+80°C	-40°C~+85°C

#### Notes

1. Derate linearly as shown in derating curve.

2. Duty Factor = 10%, Frequency = 1 kHz

#### **Electrical Characteristics** $T_A = 25$ °C (Note 1)

Parameters	Symbol	Min.	Тур.	Max.	Unit	Test Condition
Luminous Intensity	IV	1000	1500		mcd	IF=60mA
Viewing Angle	201/2		120		Deg	IF=60mA
Peak Emission Wavelength	λр		462		nm	IF=60mA
Dominant Wavelength	λd		465		nm	IF=60mA
Spectral Line Half-Width	Δλ		20		nm	IF=60mA
Forward Voltage	VF	2.8	3.2	3.6	V	IF=60mA
Reverse Current	IR			10	μA	V <sub>R</sub> =5V

#### Notes

1. Luminous intensity is measured with a light sensor and filter combination that approximates the CIE eye-response curve.

2. 201/2 is the o -axis angle where the luminous intensity is 1/2 the peak intensity

3. The dominant wavelength ( $\lambda d$ ) is derived from the CIÉ chromaticity diagram and represents the single wavelength which defines the color of the device.

#### **ESD** Precaution

ATTENTION: Electrostatic Discharge (ESD) protection

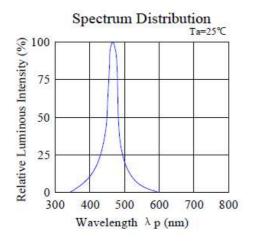


The symbol above denotes that ESD precaution is needed. ESD protection for GaP and AlGaAs based chips is necessary even though they are relatively safe in the presence of low static-electric discharge. Parts built with AlInGaP, GaN, or/and InGaN based chips are STATIC SENSITIVE devices. ESD precaution must be taken during design and assembly. If manual work or processing is needed, please ensure the device is adequately protected from ESD during the process.

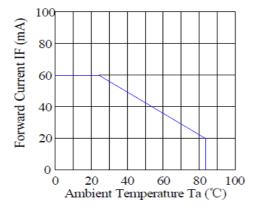
Please be advised that normal static precautions should be taken in the handling and assembly of this device to prevent damage or degradation which may be induced by electrostatic discharge (ESD).

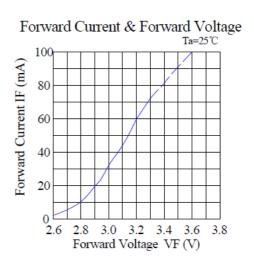


# **Typical Characteristic Curves**

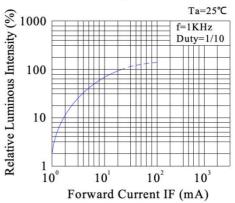


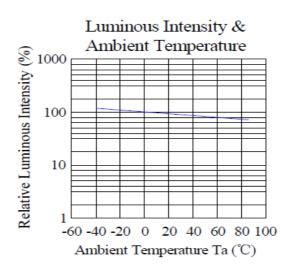
Forward Current Derating Curve





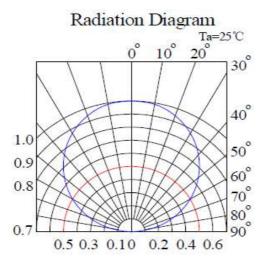
Luminous Intensity & Forward Current







# **Typical Characteristic Curves – Radiation Pattern**

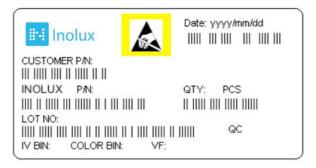


# **Ordering Information**

Product	Emission Color	Test Current I <sub>F</sub> (mA)	Luminous Intensity Iv (mcd) (Typ.)	Forward Voltage V <sub>F</sub> (V) (Typ.)	Orderable Part Number
IN-P23CTJB	Blue	60	1500	3.2	IN-P23CTJB



# **Label Specifications**



#### **Inolux P/N:**

Ι	Ν	-	Р	2	3	С	Т	J	В	-	Х	Х	Х	Х
			Material	Pack	Package Variation		Orientation	Current	Color		Customized Stamp-off			
Ino SN			P = PLCC Type	23C	=PLCC	2 2835 Slug	T = Top Mount	J=60mA	B= Blue					

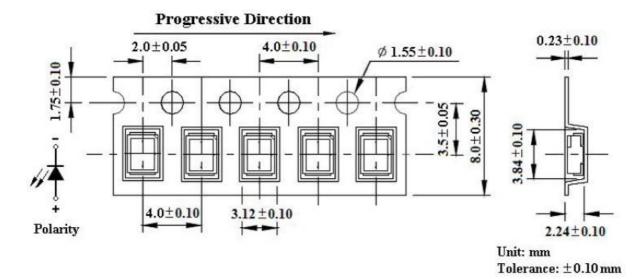
#### Lot No.:

Z	2	0	1	8	01	24	001
Internal		Voar (2019	, 2019,)	Month	Data	Serial	
Tracker		fear (2018	, 2019,)	wonth	Date	Serial	

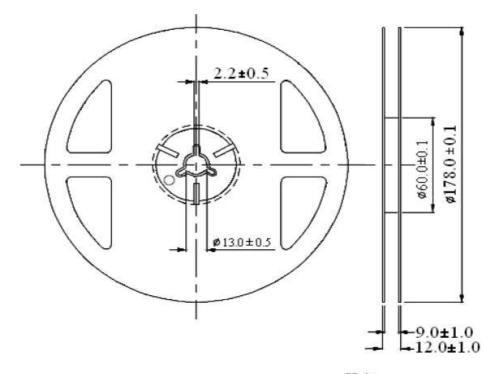


## Packaging Information: 4000pcs Per Reel

# Tape Dimension

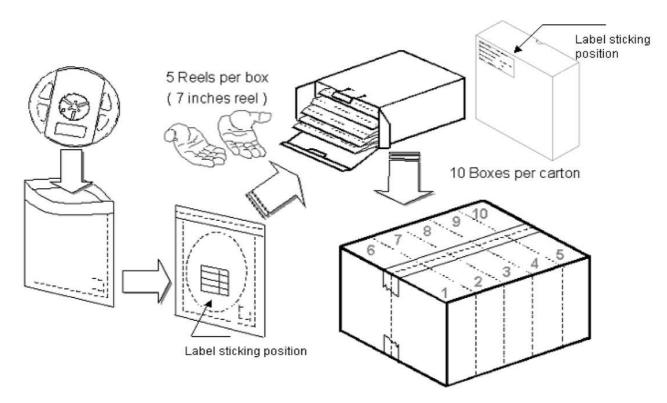


# **Reel Dimension**





# Packing Dimension



5 boxes per carton are available depending on shipment quantity.

Specification	Material	Quantity
Per EIA 481-1A specs	Conductive black tape	4000pcs per reel
Per EIA 481-1A specs	Conductive black	
IN standard	Paper	
220x240mm	Aluminum laminated bag/ no-zipper	One reel per bag
IN standard	Paper	Non-specified
	Per EIA 481-1A specs Per EIA 481-1A specs IN standard 220x240mm	Per EIA 481-1A specsConductive black tapePer EIA 481-1A specsConductive blackIN standardPaper220x240mmAluminum laminated bag/ no-zipper

Others:

Each immediate box consists of 5 reels. The 5 reels may not necessarily have the same lot number or the same bin combinations of Iv,  $\lambda_D$  and Vf. Each reel has a label identifying its specification; the immediate box consists of a product label as well.

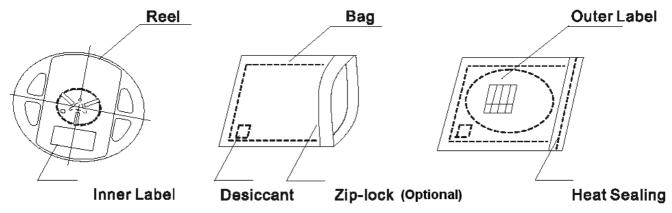


# **Dry Pack**

All SMD optical devices are **MOISTURE SENSITIVE**. Avoid exposure to moisture at all times during transportation or storage. Every reel is packaged in a moisture protected anti-static bag. Each bag is properly sealed prior to shipment.

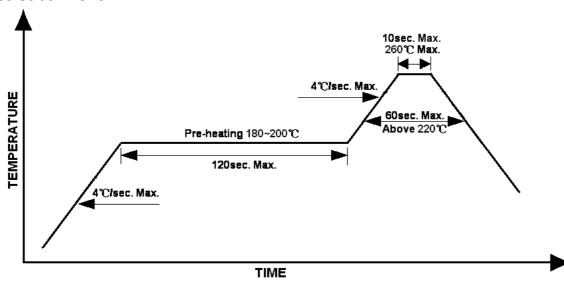
Upon request, a humidity indicator will be included in the moisture protected anti-static bag prior to shipment.

The packaging sequence is as follows:



### **Reflow Soldering**

- Recommended tin glue specifications: melting temperature in the range of 178~192 °C
- The recommended reflow soldering profile is as follows (temperatures indicated are as measured on the surface of the LED resin):



Lead-free Solder Profile



## Precautions

- Avoid exposure to moisture at all times during transportation or storage.
- Anti-Static precaution must be taken when handling GaN, InGaN, and AlInGaP products.
- It is suggested to connect the unit with a current limiting resistor of the proper size. Avoid applying a reverse voltage.
- Avoid operation beyond the limits as specified by the absolute maximum ratings.
- Avoid direct contact with the surface through which the LED emits light.
- If possible, assemble the unit in a clean room or dust-free environment.

#### Reworking

- Rework should be completed within 5 seconds under 260 °C.
- The iron tip must not come in contact with the copper foil.
- Twin-head type is preferred.

#### Cleaning

Following are cleaning procedures after soldering:

- An alcohol-based solvent such as isopropyl alcohol (IPA) is recommended.
- Temperature x Time should be 50°C x 30sec. or <30°C x 3min
- Ultra sonic cleaning: < 15W/ bath; bath volume ≤ 1liter
- Curing: 100 °C max, <3min

### **Cautions of Pick and Place**

- Avoid stress on the resin at elevated temperature.
- Avoid rubbing or scraping the resin by any object.
- Electro-static may cause damage to the component. Please ensure that the equipment is properly grounded. Use of an ionizer fan is recommended.



### **Revision History**

Changes since last revision	Page	Version No.	Revision Date
Initial Release		V1.0	04-02-2020

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